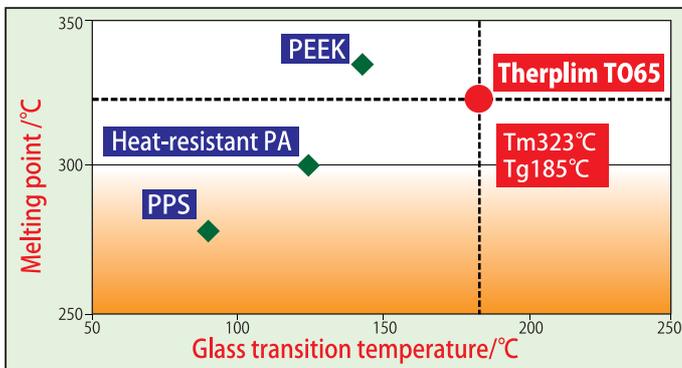
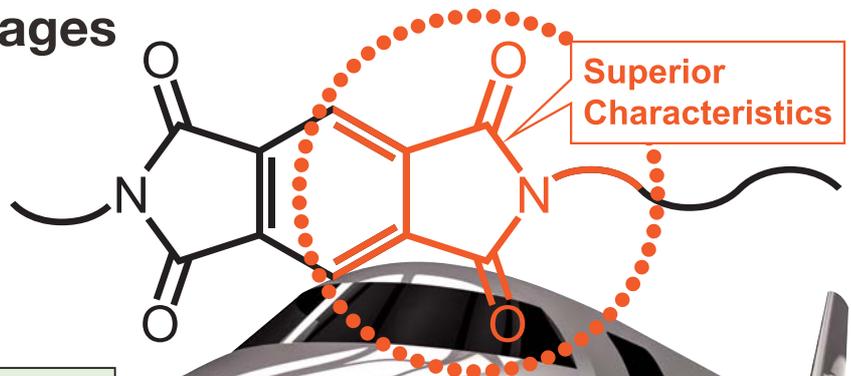


"Therplim" Thermoplastic Polyimide

■ Structure and Advantages

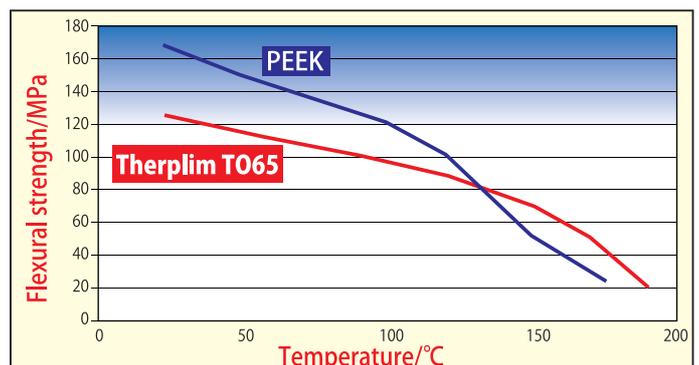
- Good moldability
~ Moldable at 340~360°C ~
- High heat-resistance
~ Tg higher than PEEK ~
- Semi-crystalline



- High strength
- Low water absorption
~ as well as PEEK ~

- Stronger than PEEK over 100°C because of its high Tg.

	Unit	T065
Flexural Strength	Mpa	120
Flexural Modulus	Gpa	2.6
Tensile Strength	Mpa	80
Tensile Modulus	Gpa	2.5
Tensile Strain	%	21
Oxygen index	-	23.6
Water absorption	%	0.1
Permittivity (ε)	-	2.66 (10.GHz)



Specialty Polyimide "Therplim"

■ **Molding Example** Therplim forms : pellet and powder (about 20μm).
Therplim has good moldability and can be molded various shapes.

Injection



- Injection Molding
 - barrel : 340~360°C
 - mold : 200°C
- Applications: gear, bearing, screw, Electronic-components.

Film



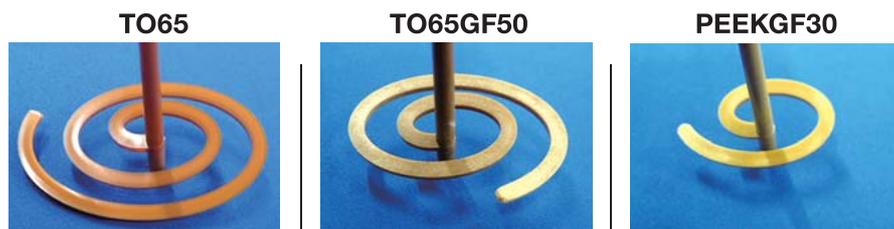
- Film Molding
 - single-screw extruder
 - barrel : 350~360°C
 - roll : 140~200°C

UL94VTM test : VTM-2 Level

■ Melt Flow

TO65/TO65GF50 has good melt-flow property in a mold.
⇒ Highly contents of filler can be compounded, for instance, GF60% and CF60% (volume of fiber).

	Condition	Unit	TO65	TO65GF50	REFERENCE EXAMPLE
Flow length	100MPa	cm	27.7	20.2	PEEKGF30
	150MPa		31.3	22.8	10.7
					11.0



Cap



CF RTP

■ Solvent resistance

High solvent resistance is derived from imide-group.

Solvent	TO65
Water	○
Methanol	○
Acetone	○
Toluene	○
Chloroform	△(swelling)
NMP	○
70%-H ₂ SO ₄	○
98%-H ₂ SO ₄	×
10%-NaOH	○
THF	○
Acetic anhydride	○

Contact & Information

Mitsubishi Gas Chemical Europe GmbH

Phone: +49-211-363080
E-Mail: contact@mgc-europe.de